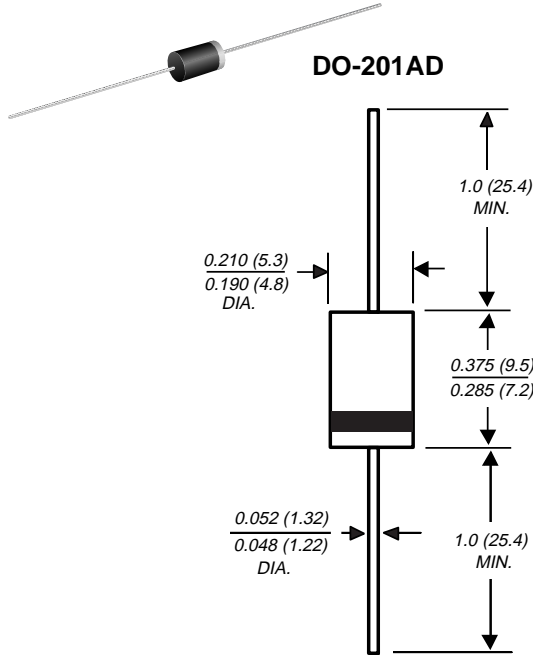


## Ultrafast Plastic Rectifier

Reverse Voltage 50 to 1000 V

Forward Current 3.0 A



Dimensions in inches and (millimeters)

### Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Glass passivated chip junction
- Low cost
- Ultrafast recovery time for high efficiency
- Low forward voltage, high current capability
- Low leakage
- High surge capability
- High temperature soldering guaranteed:  
250°C, 0.375" (9.5mm) lead length for 10 seconds,  
5 lbs. (2.3kg) tension

### Mechanical Data

**Case:** JEDEC DO-201AD molded plastic body over passivated chip

**Terminals:** Plated axial leads, solderable per MIL-STD-750, Method 2026

**Polarity:** Color band denotes cathode end

**Mounting Position:** Any

**Weight:** 0.04 ounce, 1.1 grams

## Maximum Ratings & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	UF5400	UF5401	UF5402	UF5403	UF5404	UF5405	UF5406	UF5407	UF5408	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	300	400	500	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	210	280	350	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	300	400	500	600	800	1000	V
Maximum average forward rectified current, 0.375" (9.5mm) lead length at $T_A=55^\circ\text{C}$	$I_{F(AV)}$	3.0									A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) at $T_A=55^\circ\text{C}$	$I_{FSM}$	150									A
Typical thermal resistance (NOTE 1)	$R_{\theta JA}$ $R_{\theta JL}$	20 8.5									$^\circ\text{C/W}$
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150									$^\circ\text{C}$

## Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	UF5400	UF5401	UF5402	UF5403	UF5404	UF5405	UF5406	UF5407	UF5408	UNITS
Maximum instantaneous forward voltage at 3.0A (NOTE 2)	$V_F$	1.0				1.7					V
Maximum DC reverse current at rated DC blocking voltage $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	$I_R$	75				200					$\mu\text{A}$
Maximum reverse recovery time at $I_F = 0.5\text{A}$ , $I_R = 1.0\text{A}$ , $I_{rr} = 0.25\text{A}$ $T_J = 25^\circ\text{C}$	$t_{rr}$	50				75					ns
Typical junction capacitance at 4.0V, 1MHz	$C_J$	45				36					pF

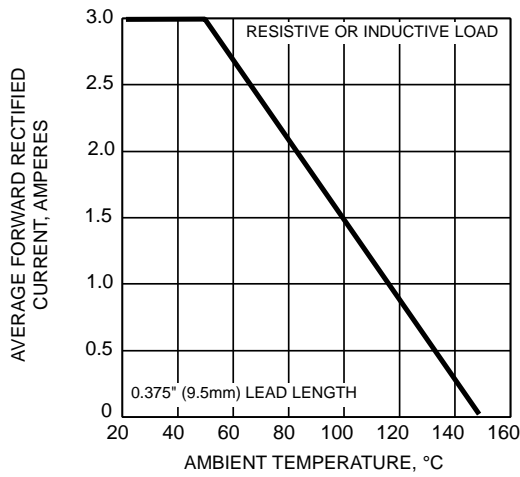
### NOTES:

(1) Thermal resistance from junction to lead and from junction to ambient with 0.375" (9.5mm) lead length, both leads attached to heatsink

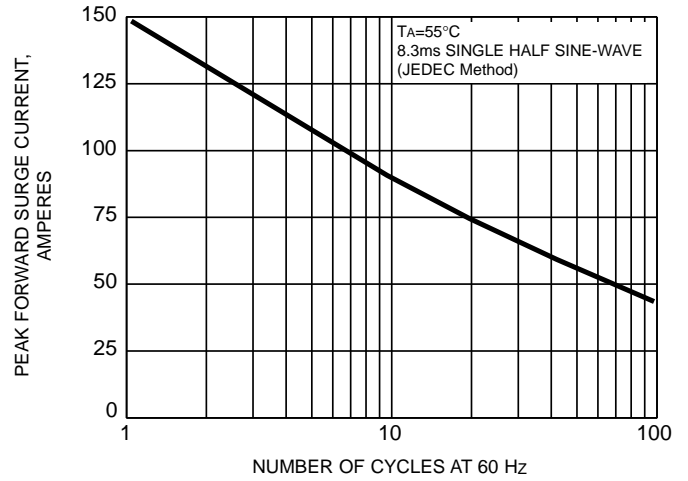
(2) Pulse test: 300 $\mu\text{s}$  pulse width, 1% duty cycle

## Ratings and Characteristic Curves (T<sub>A</sub> = 25°C unless otherwise noted)

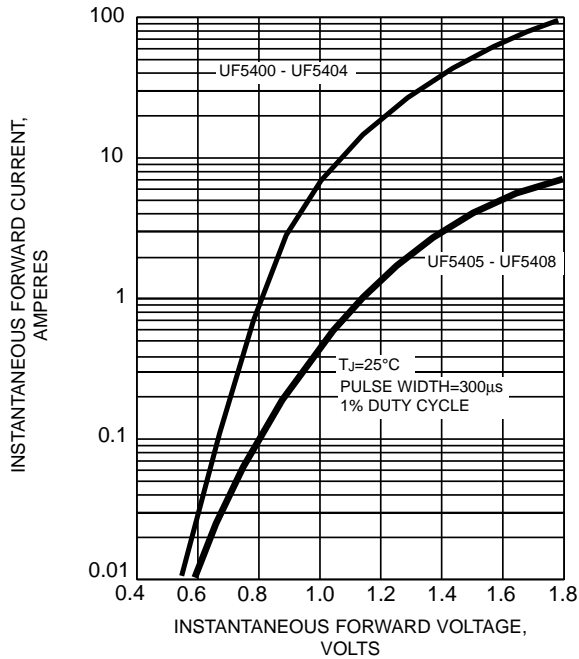
**FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE**



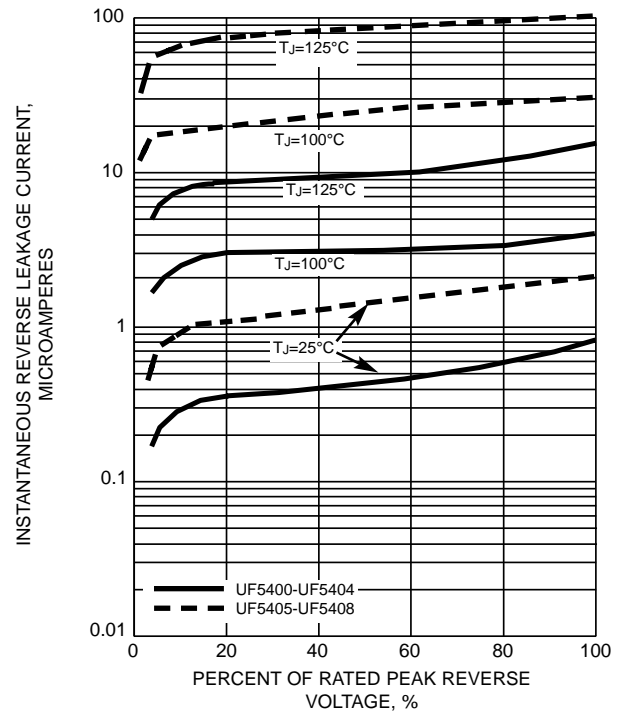
**FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT**



**FIG. 3 - TYPICAL FORWARD CHARACTERISTICS**



**FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS**



**FIG. 5 - TYPICAL JUNCTION CAPACITANCE**

